

Description

The AP220N10MP uses advanced APM-SGT r technology to provide excellent R_{DS(ON)}, low gate charge and operation with gate voltages as low as 10V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

V_{DS} = 100V I_D =220A

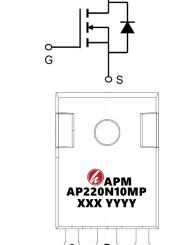
 $R_{DS(ON)} < 3.2 m\Omega$ @ $V_{GS}=10V$ (Type: 2.8 m Ω)

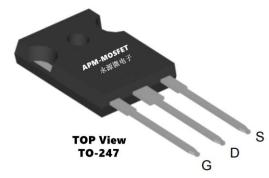
Application

DC/DC Converter

LED Backlighting

Power Management Switches





Package Marking and Ordering Information

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Product ID	Pack	Marking	Qty(PCS)
AP220N10MP	TO-247-3L	AP220N10MP XXX YYYY	1000

Absolute Maximum Ratings (T_C=25°Cunless otherwise noted)

Symbol	Parameter	Rating	Units
VDS	Drain-Source Voltage	100	V
VGS	Gate-Source Voltage	±20	V
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ 10V	220	Α
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V	180	А
IDM	Pulsed Drain Current	840	Α
EAS	Single Pulse Avalanche Energy	500	mJ
IAS	Avalanche Current	106.8	Α
P _D @T _C =25°C	Total Power Dissipation ⁴	296	W
TSTG	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
R₀JA	Thermal Resistance Junction-Ambient	0.42	°C/W
R₀JC	Thermal Resistance Junction-Case	40	°C/W

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Electrical Characteristics (Tc=25 ℃ unless otherwise noted)

	<u> </u>					
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
VDSS	Drain-Source Breakdown Voltage	V _{GS} = 0V, I _D = 250µA	100	-	-	V
IGSS	Gate-body Leakage current	V _{DS} = 0V, V _{GS} = ±20V	-	-	±100	nA
IDSS	Zero Gate Voltage Drain Current T _J =25°C	\/ -400\/ \/ - 0\/	-	-	1	
IDSS	Zero Gate Voltage Drain Current T _J =100°C	V _{DS} =100V, V _{GS} = 0V	-	-	100	μΑ
VGS(th)	Gate-Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2.0	2.9	4.0	V
RDS(on)	Drain-Source on-Resistance ²	V _{GS} = 10V, I _D = 20A	-	2.8	3.2	mΩ
Ciss	Input Capacitance		-	8800	-	
Coss	Output Capacitance	$V_{DS} = 50V, V_{GS} = 0V, f$ =1MHz	-	1290	-	pF
Crss	Reverse Transfer Capacitance		-	40	-	
Rg	Gate Resistance	$V_{GS} = 0V$, $V_{DS} = 0V$, f =1MHz	-	3.4	-	Ω
Qg	Total Gate Charge		-	150	-	
Qgs	Gate-Source Charge	$V_{GS} = 10V, V_{DS} = 50V,$ $I_{D}=20A$	-	34	-	nC
Qgd	Gate-Drain Charge	.5	-	26	-	1
td(on)	Turn-on Delay Time		-	30.8	-	ns
t _r	Rise Time	V _{GS} =10V, V _{DS} =50V, R _G =	-	26	-	113
td(off)	Turn-off Delay Time	3Ω, I _D = 20A	-	68	-	
t _f	Fall Time		-	12.4	-	
VSD	Diode Forward Voltage ²	I _F = 20A, V _{GS} = 0V	-	-	1.2	V
IS	Continuous Source Current ^{1,5}	V _G =V _D =0V , Force Current	-	-	190	Α
trr	Body Diode Reverse Recovery Time	I _F = 20A, dl/dt=100A/μs	-	110	-	ns
Qrr	Body Diode Reverse Recovery Charge	20/1, α//ατ 100/1/μο	-	202	-	nC

Notes:

- 1. The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper.
- 2. The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%
- 3. The EAS data shows Max. rating . The test condition is V_{DD} =50V, V_{GS} =10V, L=0.4mH, I_{AS}=64A
- $4_{\,{\mbox{\tiny Λ}}}$ The power dissipation is limited by 150°C junction temperature
- $5_{\text{\tiny N}}$ The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

AP220N10MP RVE1.0 永源微電子科技有限公司



Typical Characteristics

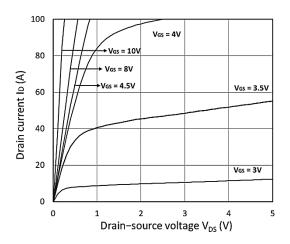


Figure 1. Output Characteristics

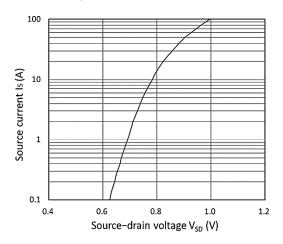


Figure 3. Forward Characteristics of Reverse

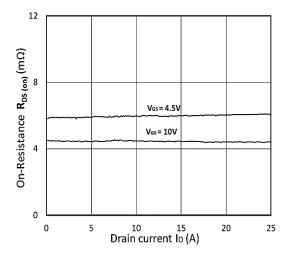


Figure 5. R DS(ON) vs. I D

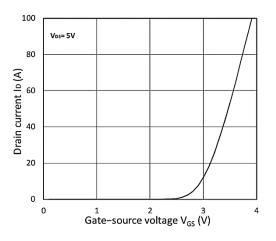


Figure 2. Transfer Characteristics

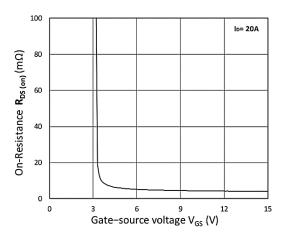


Figure 4. RDS(ON) vs. VGS

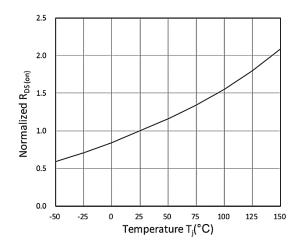


Figure 6. Normalized R DS(on) vs. Temperature





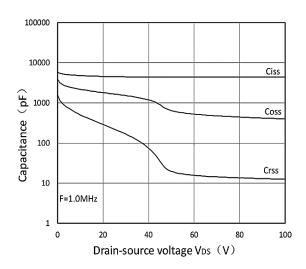


Figure 7. Capacitance Characteristics

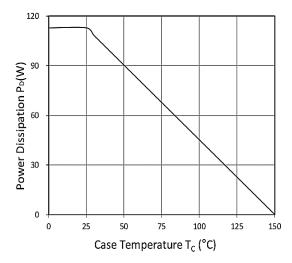


Figure 9. Power Dissipation

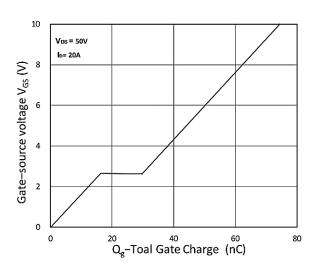


Figure 8. Gate Charge Characteristics

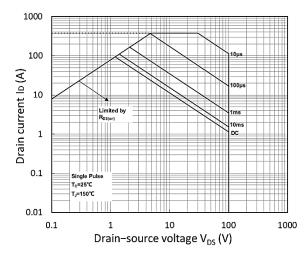


Figure 10. Safe Operating Area

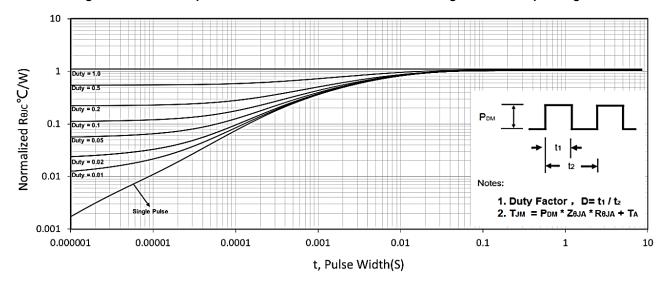
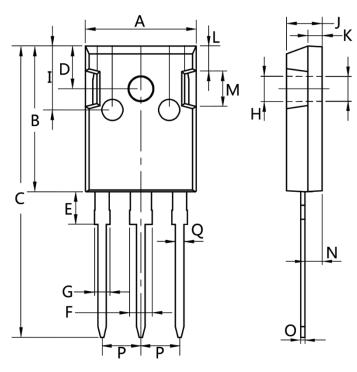


Figure 11. Normalized Maximum Transient Thermal Impedance

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Package Mechanical Data-TO-247-3L



Dim.	Min.	Max.
А	15.0	16. 0
В	20.0	21.0
С	41.0	42.0
D	5.0	6.0
E	4.0	5.0
F	2.5	3.5
G	1.75	2.5
Н	3.0	3.5
I	8.0	10.0
J	4.9	5.1
K	1.9	2.1
L	3.5	4.0
M	4.75	5.25
N	2.0	3.0
0	0.55	0.75
Р	Тур 5.08	
Q	1.2	1.3



AP220N10MP

100V N-Channel Enhancement Mode MOSFET

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Edition	Date	Change
Rve1.0	2021/8/5	Initial release

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